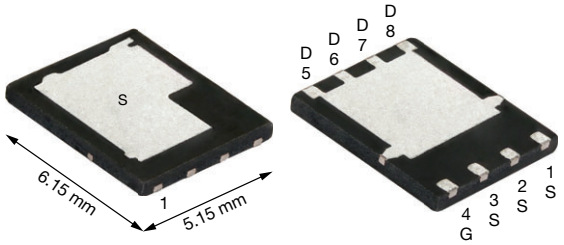
N-Channel 45 V (D-S) MOSFET

PowerPAK® SO-8DC



Top View Bottom View

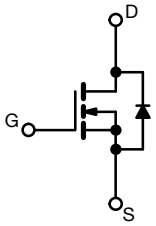
FEATURES

- TrenchFET® Gen IV power MOSFET
- 45 V Drain-source break-down voltage
- Tuned for low Q_g and Q_{oss}
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Motor drive control



N-Channel MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	45
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00120
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00180
Q_g typ. (nC)	50.5
I_D (A) [a]	208
Configuration	Single

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR608DP-T1-RE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	45	V
Gate-source voltage		V_{GS}	+20, -16	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	208	A
	T_C = 70 °C		166	
	T_A = 25 °C		51 [b, c]	
	T_A = 70 °C		40.8 [b, c]	
Pulsed drain current (t = 100 µs)		I_{DM}	400	
Continuous source-drain diode current	T_C = 25 °C	I_S	94.5	
	T_A = 25 °C		5.6 [b, c]	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	50	
Single pulse avalanche Energy		E_{AS}	125	mJ
Maximum power dissipation	T_C = 25 °C	P_D	104	W
	T_C = 70 °C		66.6	
	T_A = 25 °C		6.25 [b, c]	
	T_A = 70 °C		4 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) [d, e]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [b, f]	t ≤ 10 s	R_{thJA}	15	20	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	0.9	1.2	
Maximum junction-to-case (source)	Steady state	R_{thJC}	1.1	1.4	

Notes

a. Based on T_C = 25 °C
b. Surface mounted on 1" x 1" FR4 board
c. t = 10 s
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
f. Maximum under steady state conditions is 54 °C/W
g. Package limited

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 μA	45	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = 10 mA	-	29	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 μA	-	-5.8	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 μA	1.1	-	2.3	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = +20, -16 V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} = 45 V, V_{GS} = 0 V	-	-	1	μA
		V_{DS} = 45 V, V_{GS} = 0 V, T_J = 55 °C	-	-	10	
On-state drain current [a]	$I_{D(on)}$	$V_{DS} \geq$ 5 V, V_{GS} = 10 V	50	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 20 A	-	0.00100	0.00120	Ω
		V_{GS} = 4.5 V, I_D = 20 A	-	0.00136	0.00180	
Forward transconductance [a]	g_{fs}	V_{DS} = 10 V, I_D = 20 A	-	120	-	S
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz	-	8900	-	pF
Output capacitance	C_{oss}		-	1244	-	
Reverse transfer capacitance	C_{rss}		-	120	-	
C_{rss}/C_{iss} ratio			-	0.0135	0.0270	-
Total gate charge	Q_g	V_{DS} = 20 V, V_{GS} = 10 V, I_D = 20 A	-	111	167	nC
		V_{DS} = 20 V, V_{GS} = 4.5 V, I_D = 20 A	-	50.5	76	
Gate-source charge	Q_{gs}		-	26	-	
Gate-drain charge	Q_{gd}		-	7.8	-	
Output charge	Q_{oss}	V_{DS} = 20 V, V_{GS} = 0 V	-	59	-	
Gate resistance	R_g	f = 1 MHz	0.3	0.88	1.5	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 1 Ω $I_D \cong$ 20 A, V_{GEN} = 10 V, R_g = 1 Ω	-	19	38	ns
Rise time	t_r		-	10	20	
Turn-off delay time	$t_{d(off)}$		-	50	100	
Fall time	t_f		-	8	16	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, R_L = 1 Ω $I_D \cong$ 20 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	52	104	
Rise time	t_r		-	86	172	
Turn-off delay time	$t_{d(off)}$		-	50	100	
Fall time	t_f		-	25	50	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_C = 25 °C	-	-	94.5	A
Pulse diode forward current (t_p = 100 μs)	I_{SM}		-	-	400	
Body diode voltage	V_{SD}	I_S = 10 A	-	0.7	1.1	V
Body diode reverse recovery time	t_{rr}	I_F = 10 A, di/dt = 100 A/μs, T_J = 25 °C	-	52	104	ns
Body diode reverse recovery charge	Q_{rr}		-	71	142	nC
Reverse recovery fall time	t_a		-	32	-	ns
Reverse recovery rise time	t_b		-	20	-	

Notes

a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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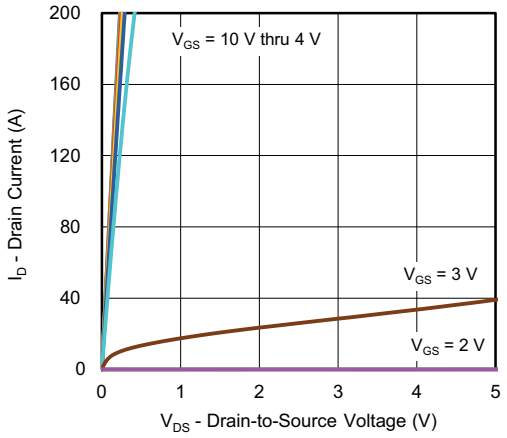
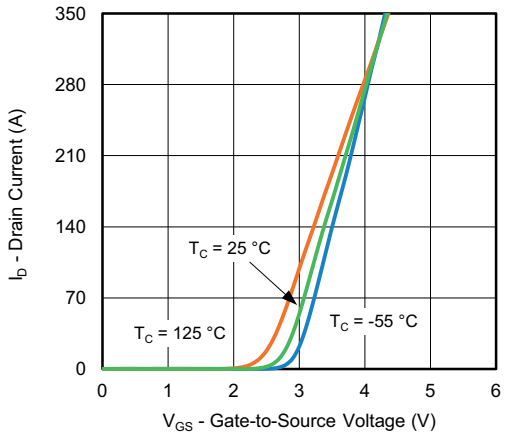
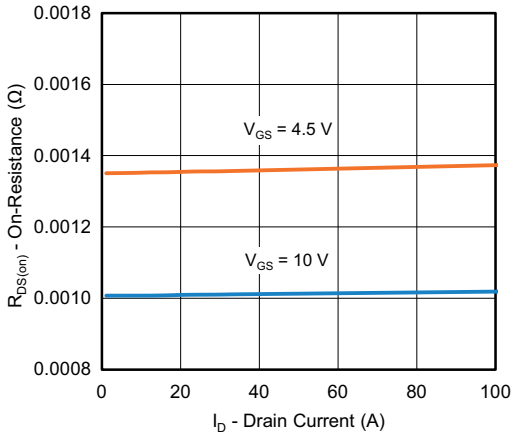


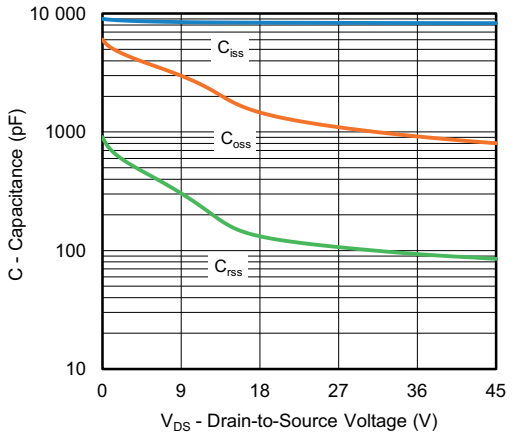
Output Characteristics



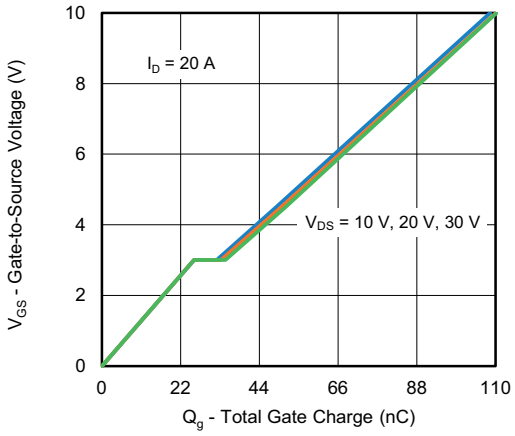
Transfer Characteristics



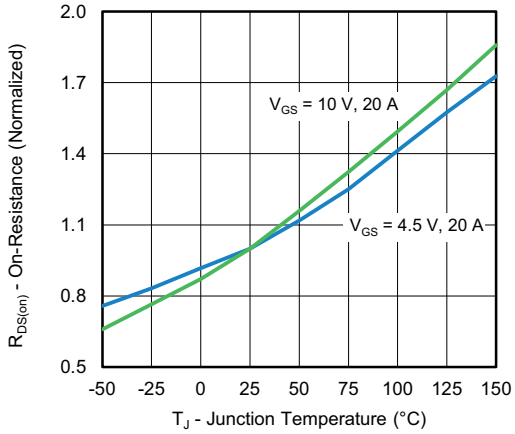
On-Resistance vs. Drain Current



Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

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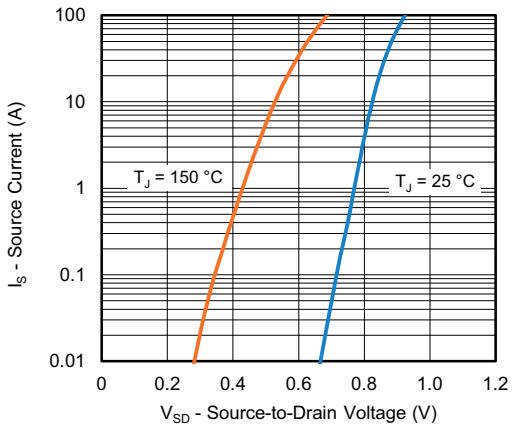
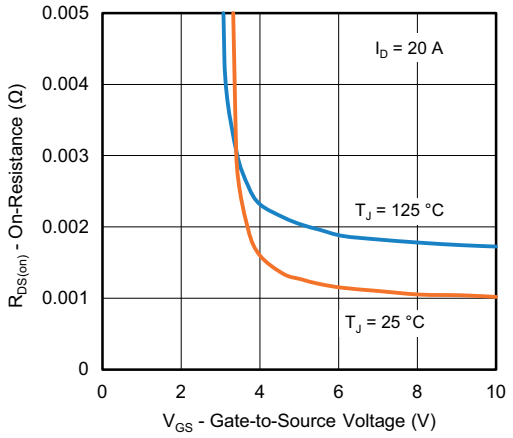
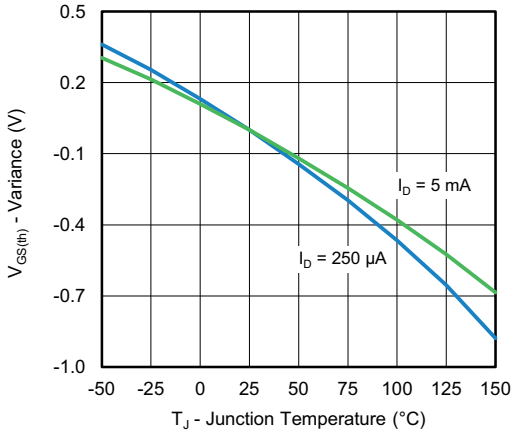


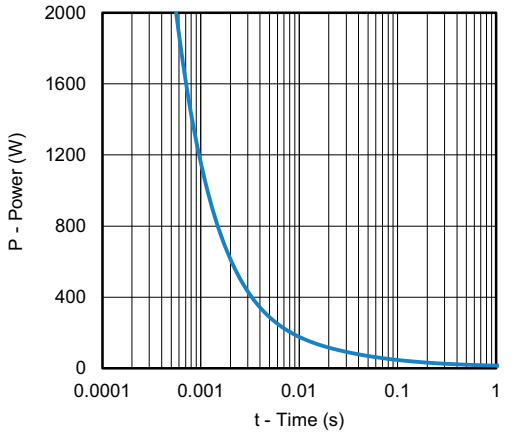
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

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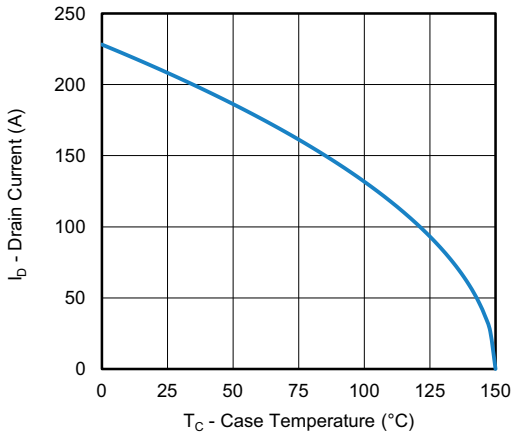
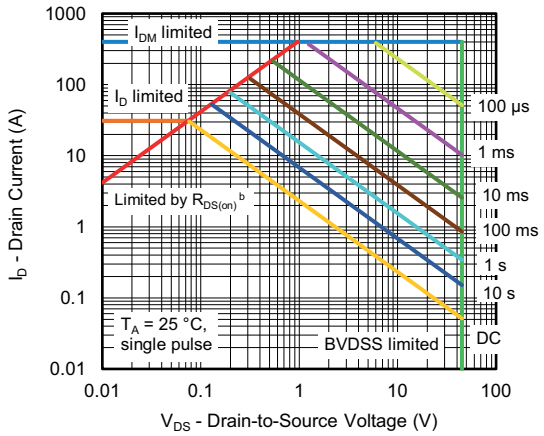
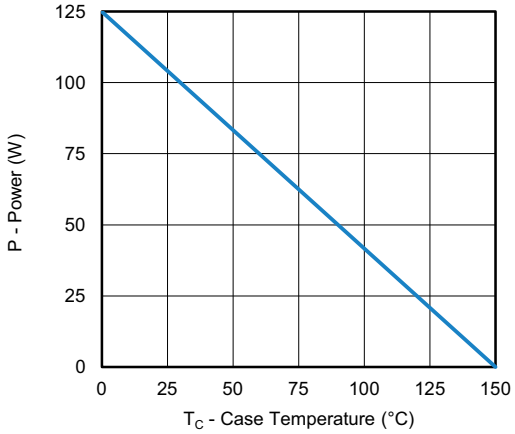


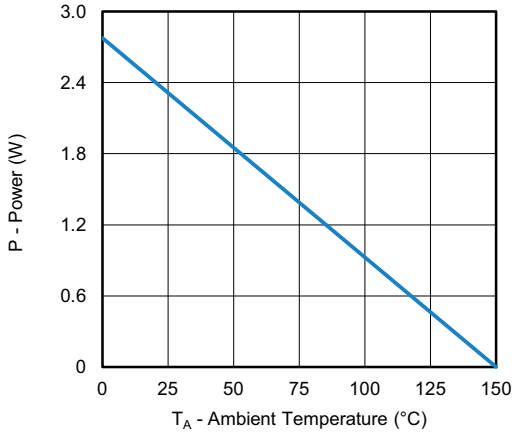
Current Derating [a]



Safe Operating Area



Power, Junction-to-Case



Power, Junction-to-Ambient

Notes

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

b. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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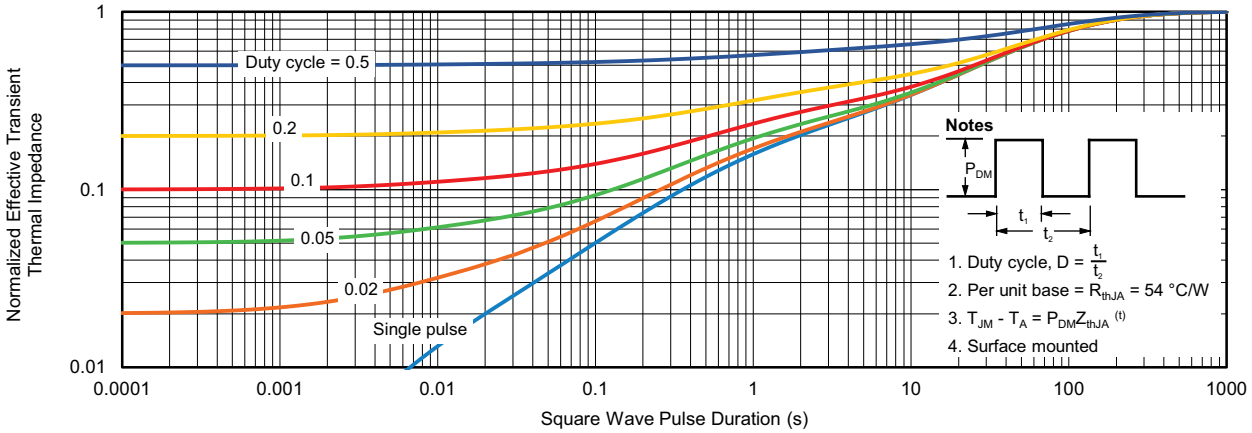
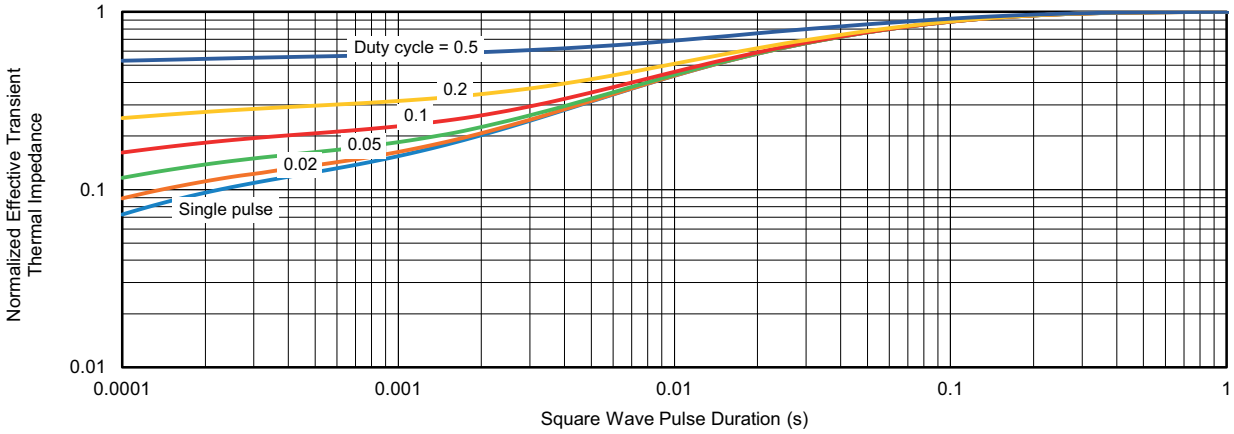


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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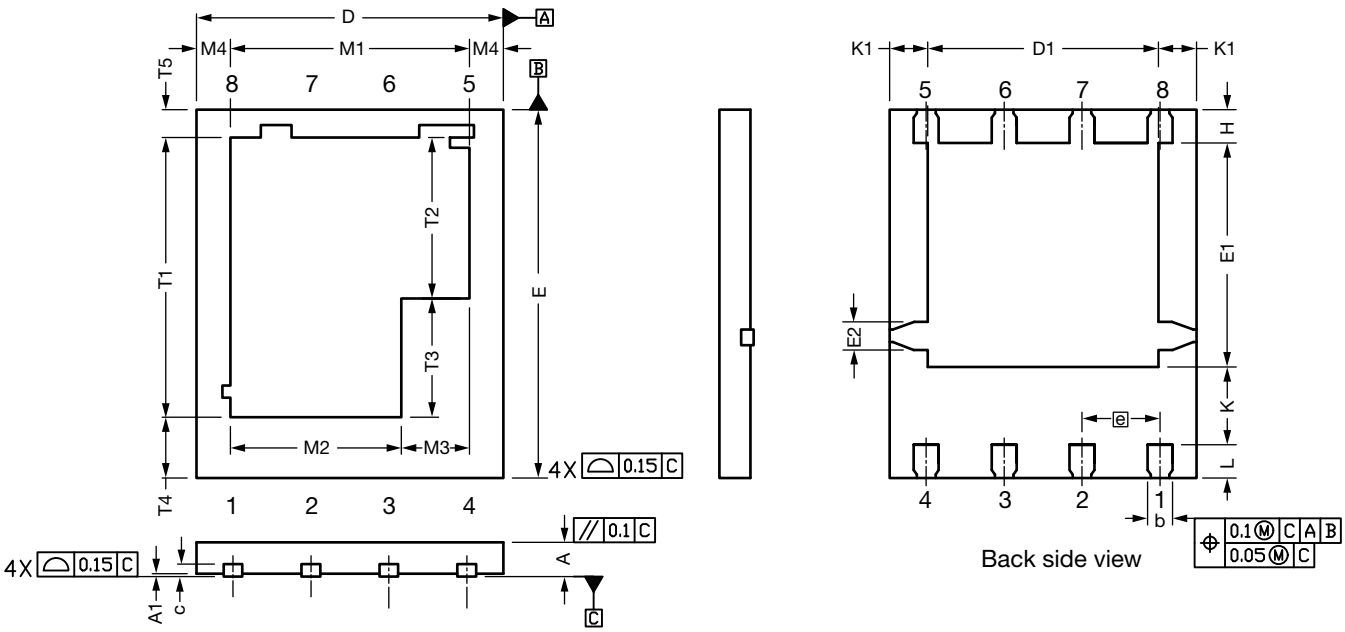
PowerPAK® SO-8 Double Cooling Case Outline



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.51	0.56	0.63	0.020	0.022	0.025
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.36	0.41	0.46	0.014	0.016	0.018
c	0.15	0.20	0.25	0.006	0.008	0.010
D	4.90	5.00	5.10	0.193	0.197	0.201
D1	3.71	3.76	3.81	0.146	0.148	0.150
e	1.27 BSC			0.050 BSC		
E	5.90	6.00	6.10	0.232	0.236	0.240
E1	3.60	3.65	3.70	0.142	0.144	0.146
E2	0.46 typ.			0.018 typ.		
H	0.49	0.54	0.59	0.019	0.021	0.023
K	1.22	1.27	1.32	0.048	0.050	0.052
K1	0.64 typ.			0.025 typ.		
L	0.49	0.54	0.59	0.019	0.021	0.023
M1	3.8	3.90	4.00	0.150	0.154	0.158
M2	2.69	2.79	2.89	0.106	0.110	0.114
M3	1.01	1.11	1.21	0.040	0.044	0.048
M4	0.56 typ.			0.022 typ.		
N	8			8		
T1	4.46	4.56	4.66	0.176	0.180	0.184
T2	2.53	2.63	2.73	0.100	0.104	0.108
T3	1.83	1.93	2.03	0.072	0.076	0.080
T4	0.97 typ.			0.038 typ.		
T5	0.48 typ.			0.019 typ.		
ECN: T26-0372-Rev. D, 14-Sep-2026 DWG: 6048						

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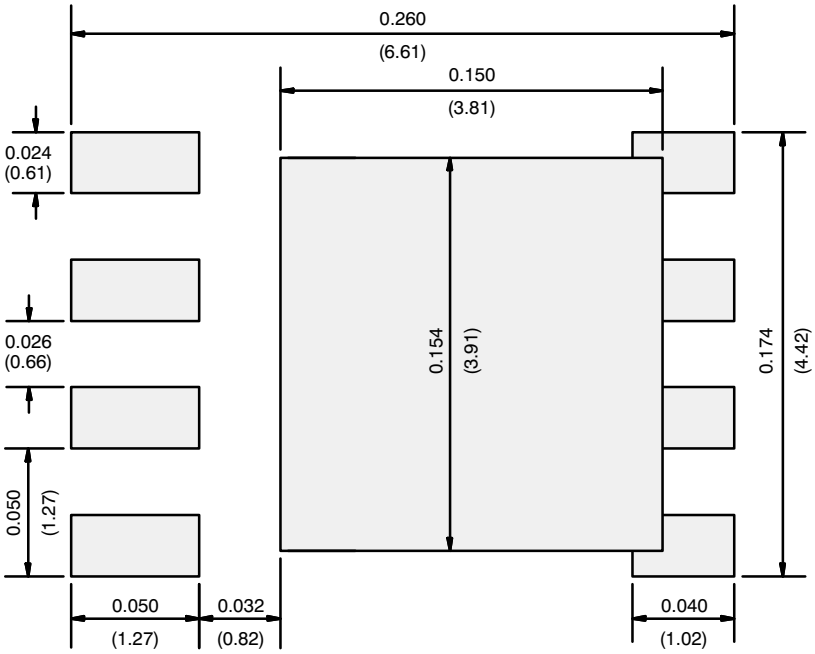
RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads
Dimensions in Inches/(mm)

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